

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20180621001 Datasheet for TS3A5018 Change Notification

Date: July 03, 2018

To: PREMIER FARNELL PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Data Sheet Change Notification Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TS3A5018DBQR	null
TS3A5018D	null
TS3A5018PW	null
TS3A5018RGYR	null
TS3A5018RSVR	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20180621001			PCN Date:		July 3, 2018		
Title: Datasheet for TS3A5018								
Customer Contact:	PCN Manager De				Dep	ot:	Quality Services	
Proposed 1 st Ship Da	ote: October 3, 2018							
Change Type:								
Assembly Site			Design				Wafer	Bump Site
Assembly Process			Data Shee	t			Wafer	Bump Material
Assembly Materials			Part numb	er chai	nge		Wafer	Bump Process
Mechanical Specific			Test Site				Wafer	Fab Site
Packing/Shipping/	_abeli	ng	Test Proce	SS			Wafer	Fab Materials
							Wafer	Fab Process
Notification Details								
Description of Change:								
Texas Instruments Incorporated is announcing an information only notification.							n.	
The product datasheet(s) is l	peing upda	ated as sum	marize	d below.			
TEXAS								TC2 / E049
INSTRUMENTS						SCDS1	189H _ IAN	TS3A5018 UARY 2005-REVISED MAY 2018
						3003	10311-0214	DART 2003-REVISED WAT 2010
Changes from Revision G (March 2015) to Revision H Page								
Changed the pinout images								
• Changed the r_{on} MAX value at 25°C From: 8 Ω To: 17 Ω in the <i>Electrical Characteristics for 1.8-V Supply</i> table								
								1.8-V Supply table7
The datasheet number	will b	e changing	<u>].</u>					
Device Family			Change From:					Change To:
TS3A5018 SCDS189G			G		SCDS189H			
http://www.ti.com/product/TS3A5018								
Reason for Change:								
To accurately reflect device characteristics.								
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):							tive / negative):	
Electrical specification performance changes as indicated above.								
Changes to product identification resulting from this PCN:								
None.								
Product Affected:								
TS3A5018D	TS	3A5018DE	3QR	TS3A.	5018DBQ	RE4	T	S3A5018DBQRG4
TS3A5018DE4	TS	3A5018D0	GVR	TS3A.	5018DR		T	S3A5018DRE4
TS3A5018PW	TS	3A5018PV	VG4	TS3A	5018PWR		T	S3A5018PWRE4
TS3A5018RGYR	TS	3A5018R0	GYRG4	TS3A.	5018RSV	R		

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com

Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com